

Electronic Acknowledgement Receipt

EFS ID:	7999288
Application Number:	10786807
International Application Number:	
Confirmation Number:	3341
Title of Invention:	Method for improving semiconductor wafer test accuracy
First Named Inventor/Applicant Name:	Hui-Mei Chen
Customer Number:	89518
Filer:	Dennis Alan Duchene/Tobi Herbert
Filer Authorized By:	Dennis Alan Duchene
Attorney Docket Number:	085027-0106
Receipt Date:	12-JUL-2010
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Application Type:	Utility under 35 USC 111(a)

Payment information:

Submitted with Payment	yes
Payment Type	Deposit Account
Payment was successfully received in RAM	\$940
RAM confirmation Number	6153
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Authorized User	

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)
1	Transmittal Letter	085027_0106_Transmittal.pdf	31201 6182f6d2e6ubc59392b75e630ac182312ca166c	no	1

Warnings:

Information:

2	Request for Continued Examination (RCE)	085027_0106_RCE.pdf	35035 e0114954b6e0bae0d9712661d2a5cf32203>4	no	1
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Warnings:

This is not a USPTO supplied RCE SB30 form.

Information:

3		085027_0106_Amendment.pdf	59009 b289fa53..d127ca094e3264bb0941fb5d3bfca	yes	9
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Multipart Description/PDF files in .zip description

Document Description	Start	End
Amendment Submitted/Entered with Filing of CPA/RCE	1	1
Claims	2	4
Applicant Arguments/Remarks Made in an Amendment	5	9

Warnings:

Information:

4	Miscellaneous Incoming Letter	085027_0106_Entity_Change.pdf	18077 a72fe34a02c8a085a77b6de52275fec5d11cb3ff	no	1
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Warnings:

Information:

5	Fee Worksheet (PTO-875)	fee-info.pdf	31803 1dd4ba0635be901139cc93ec557af0fb4d05f175	no	2
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Information:

Total Files Size (in bytes): 175125

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

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